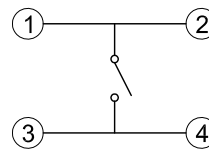
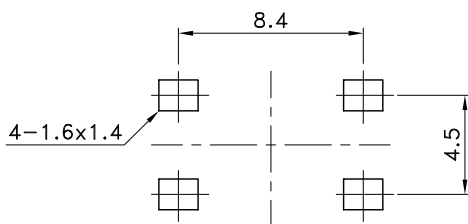


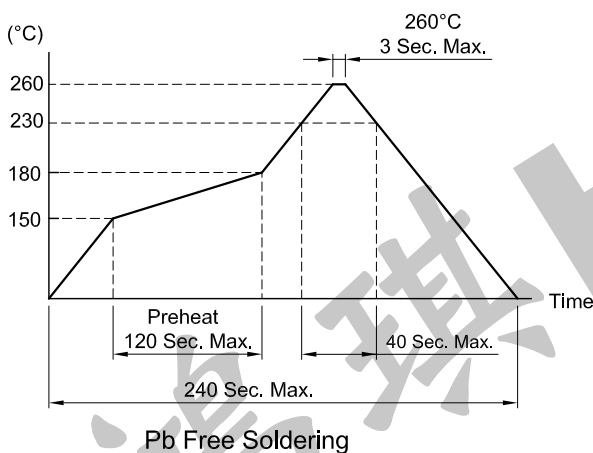
P.C.B TERMINAL POSITION

CIRCUIT ARRANGEMENT



REFLOW SOLDERING CONDITIONS

SPECIFICATIONS



1. Rating : DC 12V 50mA
2. Contact Resistance : 100mΩ Max.
3. Insulation Resistance : 100MΩ Min. at DC 100V.
4. Dielectric Strength : AC 250V for 1 Minute
5. Operating Force : 160±50 gf
6. Stroke : 0.25^{+0.2}_{-0.1} mm
7. Life : 1,000,000 Cycles
8. Operating Temperature Range : -30~+75°C
9. Storage Temperature Range : -40~+85°C
10. Reflow Soldering Profile : According Reflow Profile Max. 2 Times

REVISION:		DATE:		REVISION:		DATE:	
UNIT:mm	THIRD ANGLE PROJECTION METHOD	TOL. UNLESS OTHERWISE STATED:±0.3		CODE NO.:HCH-1909			
ISSUED	CONFIRMED	 HCH HORNG CHIH <small>ISO9001 Certified</small> <small>ISO14001 Certified</small> 鴻琪股份有限公司				PART NO.	
John	Elvis					STS-189	
2014.01.24	2014.01.24						